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DECLARATION FOR PATENT APPLICATION		Docket Number (Optional)	
As a below named inventor, I hereby	y declare that:		MR1035-1455
My residence, post office address ar	nd citizenship are as stated below	next to my name.	
I believe I am the original, first and s names are listed below) of the subje- COPPER/COPPER ALLOY SURFACE B which is attached hereto unless the f	oct matter which is claimed and for BONDING PROMOTOR AND ITS 1152/	which a natent is cought on th	ne invention entitled
	as United States Ap	oplication Number or PCT Inter	rnational Application
	and was amended on		
I hereby state that I have reviewed a amended by any amendment referrer I acknowledge the duty to disclose in I hereby claim foreign priority bene or inventor's certificate, or § 365(a) of United States, listed below and have certificate, or PCT International application Foreign Application(s)	d to above. Iformation which is material to pate If its under 35 U.S.C. § 119(a)-(d) If any PCT International application also identified below, by checking	entability as defined in 37 CFR) or § 365(b) of any foreign a n which designated at least on the box, any foreign application	R §1.56. application(s) for patent ne country other than the on for patent or inventor's a priority is claimed. Priority Not Claimed
(Number)	(Country)	(Day/Month/Year Filed)	
	•	•	
(Number)	(Country)	(Day/Month/Year Filed)	
I hereby claim the benefit under 35 U	.S.C. § 119(e) of any United State	s provisional application(s) list	led below.
/AU-ALALA			
(Application Number)	(Filing Date)		
(Application Number) I hereby claim the benefit under 35 tapplication designating the United States and disclosed in the prior United States U.S.C. § 112. I acknowledge the duty to disclose inforwardable between the filing date of the	ates, listed below and, insofar as that at the state or PCT International application of the pate formation which is material to pate	he subject matter of each of the on in the manner provided by the control of the	ne claims of this application the first paragraph of \$ 1.56 which became
(Application Number)	(Filing Date)	(Status-pate	ented, pending, abandoned)
(Application Number) I hereby appoint the following attorney and Trademark Office connected there DAVID R. WOOD, 53868; Address all telephone calls to Address all correspondence to	ewith: MORTON J. ROSENBERG DAVID I. KLEIN, ESQ., RE MORTON J. ROSENBERG ROSENBERG, KLEIN & LE 3458 ELLICOTT CENTER ELLICOTT CITY, MD 2104 FAX #: 410-461-3067 E-MAIL ADDRESS: rkl@rk	his application and to transact 3, ESQ., REG. # 26,049; HAR G. # 33,253; JUN Y. LEE, ESG at telephone number 410-46; EE DRIVE-SUITE 101 43 «Ipatlaw.com	RY L. SERNAKER 5059 Q., REG. # 40,262 5-6678
I hereby declare that all statements ma and belief are believed to be true; and and the like so made are punishable b	further that these statements wer	e made with the knowledge th	nat willful false statements

Mailing Address TAOYUAN, CITY TAOYUAN HSIEN, TAIWAN, R.O.C.

14 FL, NOIT, LANES B, PAO SHAN ST

Full name of second joint inventor, if any (given name, family name)

Second Inventor's signature _

Citizenship Mailing Address

Additional Inventors are being named on separately numbered sheets attached hereto.